

**3A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER
POWERDI[®]5**

Product Summary

V_R (V)	I_F (A)	$V_{F\ MAX}$ (V) @ +25°C	$I_{R\ MAX}$ (mA) @ +25°C
100	3.0	0.76	0.1

Description and Applications

This Schottky Barrier Rectifier has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as :

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

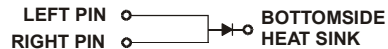
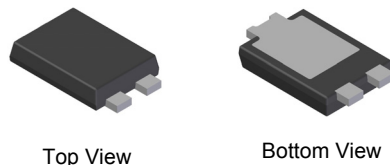
Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Leakage Current
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe Solderable per MIL-STD-202, Method 208 ③
- Polarity: See Diagram
- Weight: 0.093 grams (approximate)

POWERDI[®]5



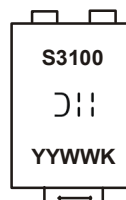
Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
PDS3100Q-13	Automotive	POWERDI5	5000/Tape & Reel
PDS3100Q-7	Automotive	POWERDI5	1500/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



S3100 = Product type marking code
 ⌋⌋⌋ = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last digit of year (ex: 14 for 2014)
 WW = Week code (01 - 53)
 K = Factory designator

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	V
RMS Reverse Voltage	$V_{R(RMS)}$	70	V
Average Rectified Output Current (see also Figure 5)	I_O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I_{FSM}	90	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	6.0	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 6) $T_A = +25^\circ\text{C}$	$R_{\theta JA}$	95	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 7) $T_A = +25^\circ\text{C}$	$R_{\theta JA}$	70	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 8) $T_A = +25^\circ\text{C}$	$R_{\theta JA}$	50	—	$^\circ\text{C/W}$
Operating Temperature Range	T_J	-65 to +150		$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +175		$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	$V_{(BR)R}$	100	—	—	V	$I_R = 0.2\text{mA}$
Forward Voltage	V_F	—	0.71	0.76	V	$I_F = 3\text{A}, T_J = +25^\circ\text{C}$
		—	0.61	0.65		$I_F = 3\text{A}, T_J = +100^\circ\text{C}$
		—	0.57	0.61		$I_F = 3\text{A}, T_J = +125^\circ\text{C}$
		—	0.78	0.84		$I_F = 6\text{A}, T_J = +25^\circ\text{C}$
		—	0.68	0.75		$I_F = 6\text{A}, T_J = +100^\circ\text{C}$
		—	0.64	0.68		$I_F = 6\text{A}, T_J = +125^\circ\text{C}$
Reverse Current (Note 9)	I_R	—	2	100	μA	$T_J = +25^\circ\text{C}, V_R = 100\text{V}$
		—	0.4	5	mA	$T_J = +100^\circ\text{C}, V_R = 100\text{V}$
		—	2	20	mA	$T_J = +125^\circ\text{C}, V_R = 100\text{V}$

- Notes:
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 - Short duration pulse test used to minimize self-heating effect.

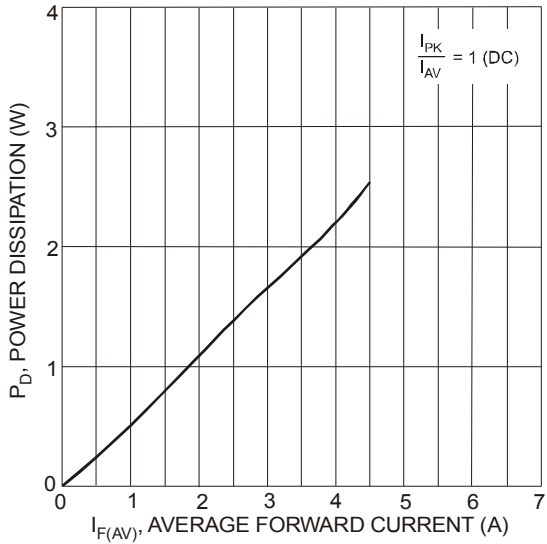


Figure 1 Forward Power Dissipation

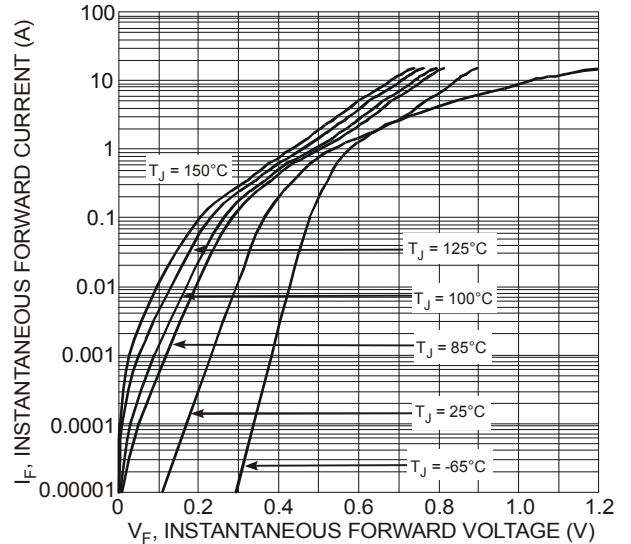


Figure 2 Typical Forward Characteristics

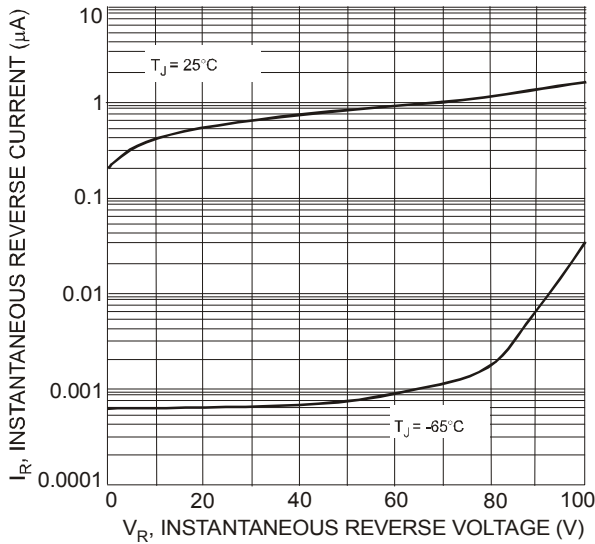


Figure 3 Typical Reverse Characteristics

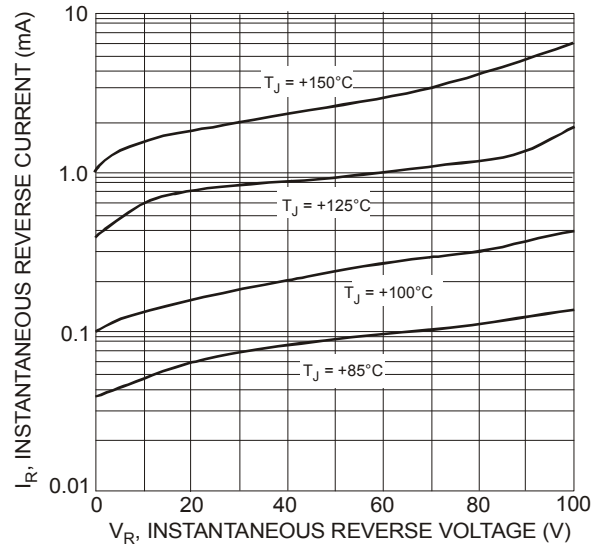


Figure 4 Typical Reverse Characteristics

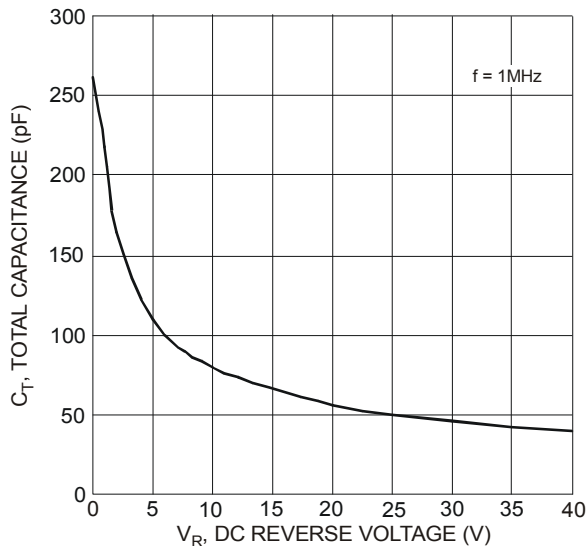


Figure 5 Total Capacitance vs. Reverse Voltage

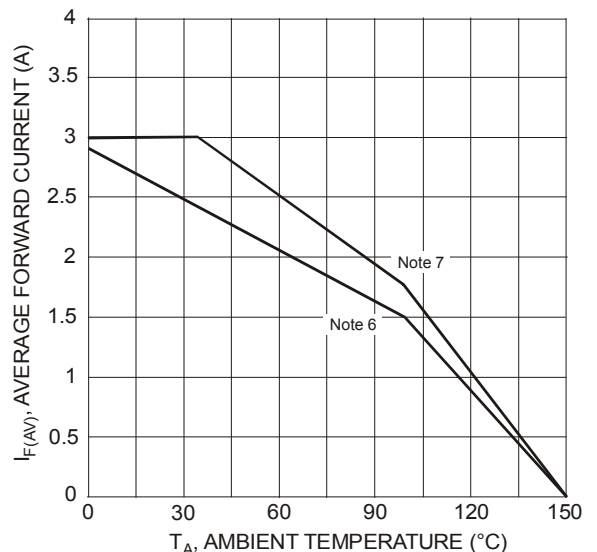


Figure 6 Forward Current Derating Curve

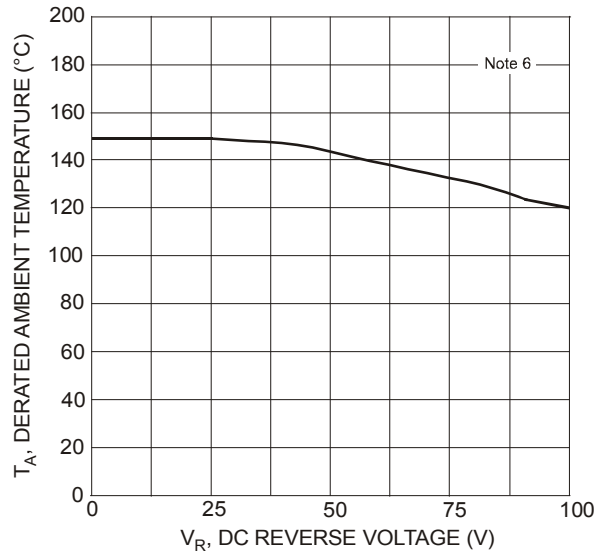
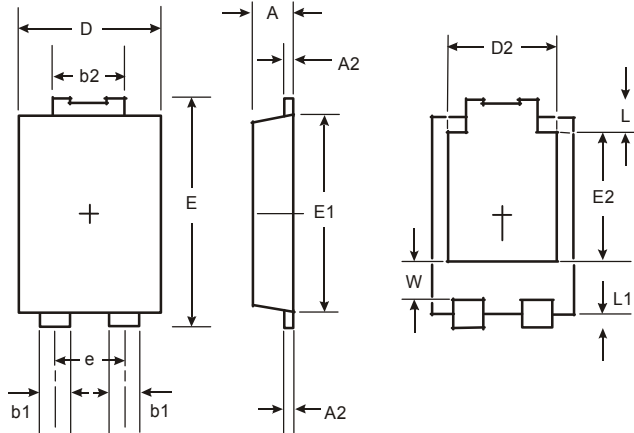


Figure 7 Operating Temperature Derating

Package Outline Dimensions

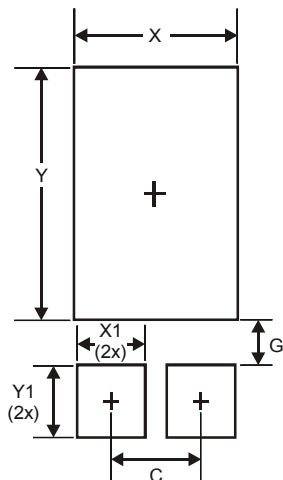
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



POWERDI5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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